AMENDMENTS TO THE CLAIMS

1. (Currently Amended) A nitride based 3-5 group compound semiconductor light emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

an In_xGa_{1-x}N/In_yGa_{1-x}N super lattice structure layer formed above the first Indoped GaN layer;

a first electrode contact layer formed above the In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure layer, the first electrode contact layer comprising a Si/In-codoped GaN layer;

an active layer formed above the first electrode contact layer and functioning to emit light;

a second In-doped GaN layer;

a GaN layer formed above the second In-doped GaN layer; and

a second electrode contact layer formed above the GaN layer;

wherein the active layer comprises a single or multiple quantum well structure, including a low mole In-doped In_xGa_{1-x}N layer, an In_yGa_{1-y}N well layer and an In_zGa_{1-z}N barrier layer, and the low mole In-doped In_xGa_{1-x}N layer has an In content smaller than that of the In_zGa_{1-z}N barrier layer.

2. (Original) The device according to claim 1, wherein the second electrode contact layer is an n-type electrode contact layer.

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3. (Original) The device according to claim 1, wherein the buffer layer comprises one selected from the group consisting of an InGaN/GaN super lattice structure, an $In_xGa_{1-x}N/GaN$ structure and an $Al_xIn_yGa_{1-x}N/In_xGa_{1-x}N/GaN$ structure.

Claim 4 (Cancelled)

5. (Original) The device according to claim 1, wherein the active layer comprises a single or multiple quantum well structure.

Claim 6 (Cancelled)

7. (Previously Presented) A nitride based 3-5 group compound semiconductor light emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure layer formed above the first Indoped GaN layer;

a first electrode contact layer formed above the $In_xGa_{1-x}N/In_yGa_{1-y}N$ super lattice structure layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a second In-doped GaN layer;

a GaN layer formed above the second In-doped GaN layer; and

a second electrode contact layer formed above the GaN layer,

wherein the active layer comprises a single or multiple quantum well structure,

including a low mole In-doped In_xGa_{1-x}N layer, an In_yGa_{1-y}N well layer and an In_zGa_{1-z}N barrier

layer, and the low mole In-doped In_xGa_{1-x}N layer has an In content smaller than that of the

In_zGa_{1-z}N barrier layer.

8. (Previously Presented) A nitride based 3-5 group compound semiconductor light

emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure layer formed above the first In-

doped GaN layer;

a first electrode contact layer formed above the In_xGa_{1-x}N/In_yGa_{1-y}N super lattice

structure layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a second In-doped GaN layer;

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a GaN layer formed above the second In-doped GaN layer; and

a second electrode contact layer formed above the GaN layer,

wherein the active layer comprises a single or multiple quantum well structure,

including a low mole In-doped In_xGa_{1-x}N layer, an In_yGa_{1-y}N well layer and an In_zGa_{1-z}N barrier

layer, and the low mole In-doped In_xGa_{1-x}N layer, the In_yGa_{1-y}N well layer and the In_zGa_{1-z}N

barrier layer have an In content expressed as 0 < x < 0.05, 0 < y < 0.3 and 0 < z < 0.1,

respectively.

9. (Currently Amended) The device according to claim 61, wherein the low mole In-

doped In_xGa_{1-x}N layer has a spiral surface configuration.

10. (Currently Amended) The device according to claim 61, wherein the low mole In-

doped In_xGa_{1-x}N layer has a spiral surface configuration, and wherein the spiral surface

configuration is extended to the surface of the In_zGa_{1-z}N barrier layer.

11. (Original) The device according to claim 1, wherein the second electrode contact

layer comprises an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure.

12. (Previously Presented) A nitride based 3-5 group compound semiconductor light

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emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

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a first In-doped GaN layer formed above the buffer layer;

an $In_xGa_{1-x}N/In_yGa_{1-y}N$ super lattice structure layer formed above the first Indoped GaN layer;

a first electrode contact layer formed above the $In_xGa_{1-x}N/In_yGa_{1-y}N$ super lattice structure layer;

an active layer formed above the first electrode contact layer and functioning to emit light;

a second In-doped GaN layer;

a GaN layer formed above the second In-doped GaN layer; and

a second electrode contact layer formed above the GaN layer,

wherein the first In-doped GaN layer and the $In_xGa_{1-x}N/In_yGa_{1-y}N$ super lattice structure layer formed thereon are repeatedly layered in plurality.

13. (Currently Amended) A nitride based 3-5 group compound semiconductor light emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure layer formed above the first Indoped GaN layer;

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a first electrode contact layer formed above the first In-doped GaN layer InxGa1.

xN/In_vGa_{1-v}N super lattice structure layer, the first electrode contact layer comprising a Si/In-

codoped GaN layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a GaN layer formed above the active layer; and

a second electrode contact layer formed above the GaN layer.

14. (Original) The device according to claim 13, wherein the second electrode contact

layer is an n-type electrode contact layer.

15. (Previously Presented) The device according to claim 13, further comprising a second

In-doped GaN layer formed between the active layer and the GaN layer, and the GaN layer is p-

type.

16. (Previously Presented) A nitride based 3-5 group compound semiconductor light

emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure layer formed above the first In-

doped GaN layer;

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a first electrode contact layer formed above the In_xGa_{1-x}N/In_yGa_{1-y}N super lattice

structure layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a GaN layer formed above the active layer; and

a second electrode contact layer formed above the GaN layer.

17. (Previously Presented) A nitride based 3-5 group compound semiconductor light

emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure and an undoped GaN layer formed

above the first In-doped GaN layer;

a first electrode contact layer formed above the In_xGa_{1-x}N/In_yGa_{1-y}N super lattice

structure and an undoped GaN layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a GaN layer formed above the active layer; and

a second electrode contact layer formed above the GaN layer.

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18. (Previously Presented) The device according to claim 13, wherein the buffer layer

comprises one selected from the group consisting of an InGaN/GaN super lattice structure, an

 $In_xGa_{1-x}N/GaN$ structure and an $Al_xIn_yGa_{1-x,y}N/In_xGa_{1-x}N/GaN$ structure.

Claim 19 (Cancelled)

20. (Original) The device according to claim 13, wherein the active layer comprises a

single or multiple quantum well structure.

21. (Original) The device according to claim 13, wherein the active layer comprises a

single or multiple quantum well structure, including a low mole In-doped In_xGa_{1-x}N layer, an

In_vGa_{1-v}N well layer and an In_zGa_{1-z}N barrier layer.

22. (Previously Presented) A nitride based 3-5 group compound semiconductor light

emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

a first electrode contact layer formed above the first In-doped GaN layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a GaN layer formed above the active layer; and

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wherein the active layer comprises a single or multiple quantum well structure, including a low mole In-doped In_xGa_{1-x}N layer, an In_yGa_{1-y}N well layer and an In_zGa_{1-z}N barrier layer, and the low mole In-doped In_xGa_{1-x}N layer has an In content smaller than that of the In_zGa_{1-z}N barrier layer.

23. (Previously Presented) A nitride based 3-5 group compound semiconductor light emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first In-doped GaN layer formed above the buffer layer;

a first electrode contact layer formed above the first In-doped GaN layer;

an active layer formed above the first electrode contact layer and functioning to

emit light;

a GaN layer formed above the active layer; and

a second electrode contact layer formed above the GaN layer,

wherein the active layer comprises a single or multiple quantum well structure, including a low mole In-doped In_xGa_{1-x}N layer, an In_yGa_{1-y}N well layer and an In_zGa_{1-z}N barrier layer, and the low mole In-doped In_xGa_{1-x}N layer, the In_yGa_{1-y}N well layer and the In_zGa_{1-z}N barrier layer have an In content expressed as 0 < x < 0.05, 0 < y < 0.3 and 0 < z < 0.1, respectively.

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24. (Currently Amended) The device according to claim 2123, wherein the low mole Indoped In_xGa_{1-x}N layer has a spiral surface configuration.

25. (Currently Amended) The device according to claim 2123, wherein the low mole Indoped In_xGa_{1-x}N layer has a spiral surface configuration, and wherein the spiral surface configuration is extended to the surface of the In_zGa_{1-z}N barrier layer.

26. (Currently Amended) The device according to claim 1323, wherein the second electrode contact layer comprises an In_xGa_{1-x}N/In_yGa_{1-y}N super lattice structure.

Claims 27-35 (Cancelled)

36. (Previously Presented) A nitride based 3-5 group compound semiconductor light emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first electrode contact layer formed above the buffer layer;

an active layer formed above the first electrode contact layer, and including a low mole In-doped In_xGa_{1-x}N layer, an In_yGa_{1-y}N well layer and an In_zGa_{1-z}N barrier layer;

a GaN layer formed above the active layer; and

a second electrode contact layer formed above the GaN layer,

wherein the low mole In-doped $In_xGa_{1-x}N$ layer has an In content smaller than that of the $In_zGa_{1-z}N$ barrier layer.

37. (Previously Presented) A nitride based 3-5 group compound semiconductor light emitting device comprising:

a substrate;

a buffer layer formed above the substrate;

a first electrode contact layer formed above the buffer layer;

an active layer formed above the first electrode contact layer, and including a low mole In-doped $In_xGa_{1-x}N$ layer, an $In_yGa_{1-y}N$ well layer and an $In_zGa_{1-z}N$ barrier layer;

a GaN layer formed above the active layer; and

a second electrode contact layer formed above the GaN layer,

wherein the low mole In-doped $In_xGa_{1-x}N$ layer, the $In_yGa_{1-y}N$ well layer and the $In_zGa_{1-z}N$ barrier layer have an In content expressed as 0 < x < 0.05, 0 < y < 0.3 and 0 < z < 0.1, respectively.

- 38. (Currently Amended) The device according to claim $34\underline{37}$, wherein the low mole Indoped In_xGa_{1-x}N layer has a spiral surface configuration.
- 39. (Currently Amended) The device according to claim $34\underline{37}$, wherein the low mole Indoped $In_xGa_{1-x}N$ layer has a spiral surface configuration, wherein the spiral surface configuration is extended to the surface of the $In_zGa_{1-z}N$ barrier layer.